



US0D1032575S

(12)

United States Design Patent

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(10)

Patent No.:

US D1,032,575 S

(45)

Date of Patent:

** Jun. 25, 2024

(54) MICROPHONE INCLUDING A MICROPHONE CAPSULE AND MODULAR GOOSENECK SECTION

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(**) Term: 15 Years

(21) Appl. No.: 29/651,841

(22) Filed: Apr. 24, 2019

(30) Foreign Application Priority Data

Oct. 31, 2018 (JP) 2018-024021

(51) LOC (14) Cl. 14-01

(52) U.S. Cl.
USPC D14/228

(58) Field of Classification Search
USPC D14/220, 224–230, 232, 233, 238;
D16/244; D17/99; D6/681; 248/125.1,
(Continued)

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(57) CLAIM

The ornamental design for a microphone including a microphone capsule and modular gooseneck section, as shown and described.

DESCRIPTION

FIG. 1 is a top perspective view of a microphone including a microphone capsule and modular gooseneck section; FIG. 2 is a bottom perspective view thereof; FIG. 3 is a front elevation view thereof; FIG. 4 is a rear elevation view thereof; FIG. 5 is a top plan view thereof; FIG. 6 is a bottom plan view thereof; FIG. 7 is a right side elevation view thereof; FIG. 8 is a left side elevation view thereof; FIG. 9 is an enlarged partial view thereof, taken from FIG. 1; FIG. 10 is another enlarged partial view thereof, taken from FIG. 1; FIG. 11 is an enlarged partial view thereof, taken from FIG. 2; FIG. 12 is another enlarged partial view thereof, taken from FIG. 2; FIG. 13 is an enlarged top plan view thereof; FIG. 14 is an enlarged bottom plan view thereof; FIG. 15 is an enlarged front elevation view of the microphone capsule portions of the microphone including a microphone capsule and modular gooseneck section; FIG. 16 is an enlarged rear elevation view thereof; FIG. 17 is an enlarged top plan view thereof; FIG. 18 is an enlarged bottom plan view thereof; FIG. 19 is an enlarged right side elevation view thereof; FIG. 20 is an enlarged left side elevation view thereof; FIG. 21 is an enlarged perspective view thereof; FIG. 22 is a front elevation view of a microphone including a microphone capsule and modular gooseneck section with the microphone capsule removed to show only the modular gooseneck portion; FIG. 23 is a rear elevation view thereof; FIG. 24 is an enlarged top plan view thereof; FIG. 25 is a bottom plan view thereof; FIG. 26 is a right side elevation view thereof; FIG. 27 is a left side elevation view thereof;

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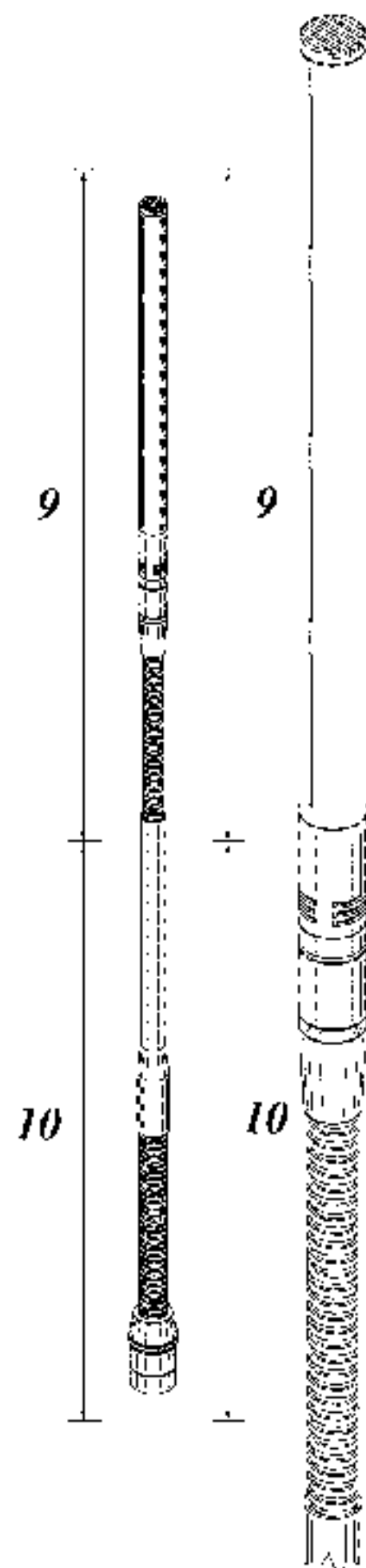


FIG. 1

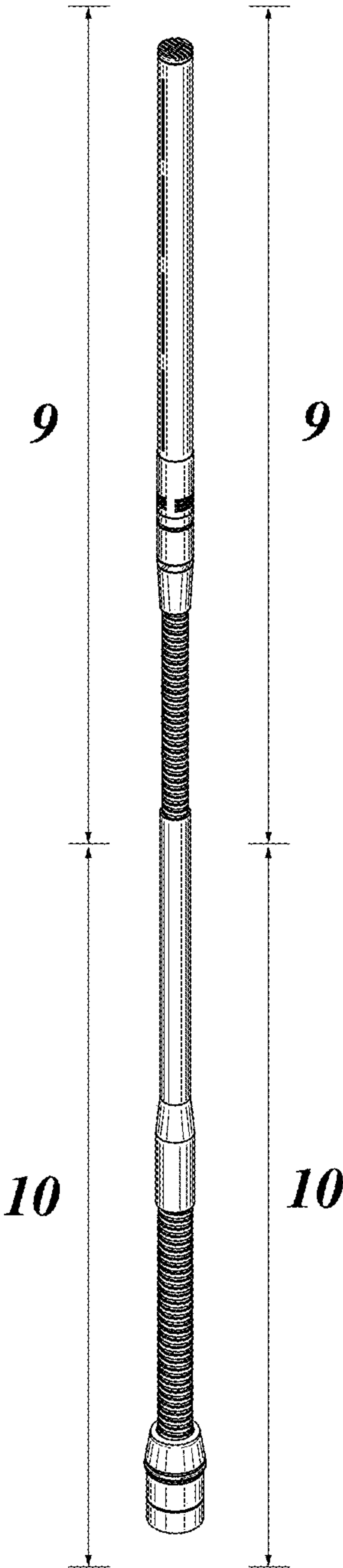


FIG. 3

